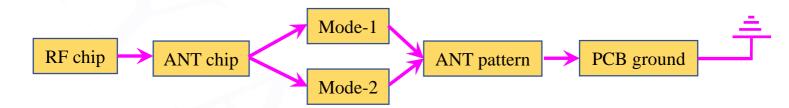
#### P/N: HY160808 SRF09

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#### **Features:**

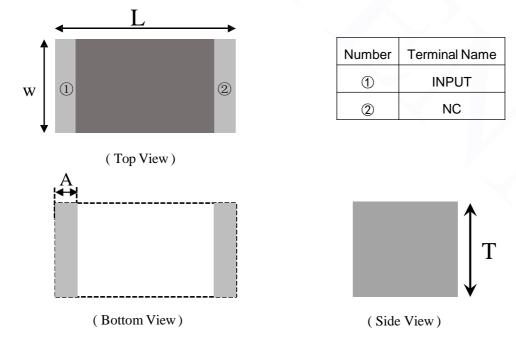
- 1. Surface mounted element with a small dimension of  $1.6 \times 0.8 \times 0.8$  mm meet future miniaturization trend.
- 2. Embedded and LTCC (low temperature co-fired ceramic) technology is able to integrate with system design as well as beatifying the housing of final product.
- 3. Miniaturization, wideband, high stability, low ESR, and low tolerance.
- 4. Dual-band resonances in the dominant and harmonic modes enables multiband operations.
- 5. Novel ground-radiation technique enables radiation from both the antenna and the ground plane.



#### ✓ Applications:

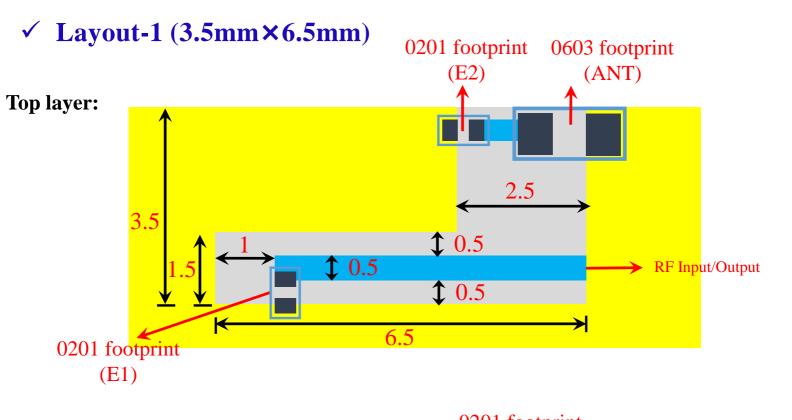
- 1. Bluetooth
- 2. Dual-band WLAN
- 3. ISM and UWB

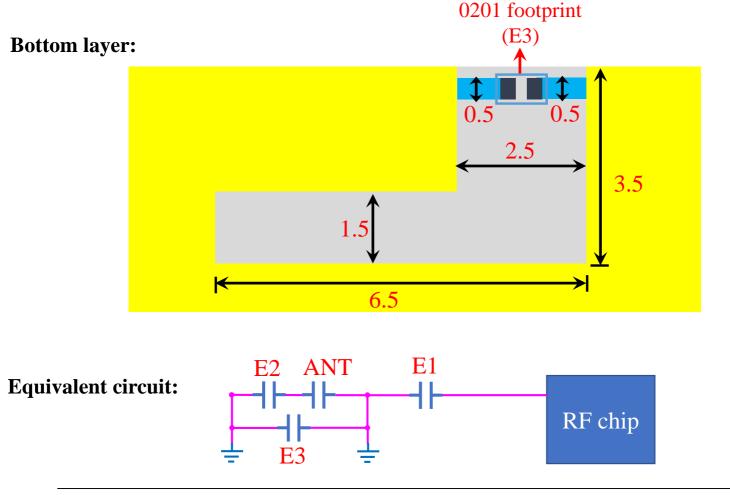
## ✓ Dimensions (Unit: mm)

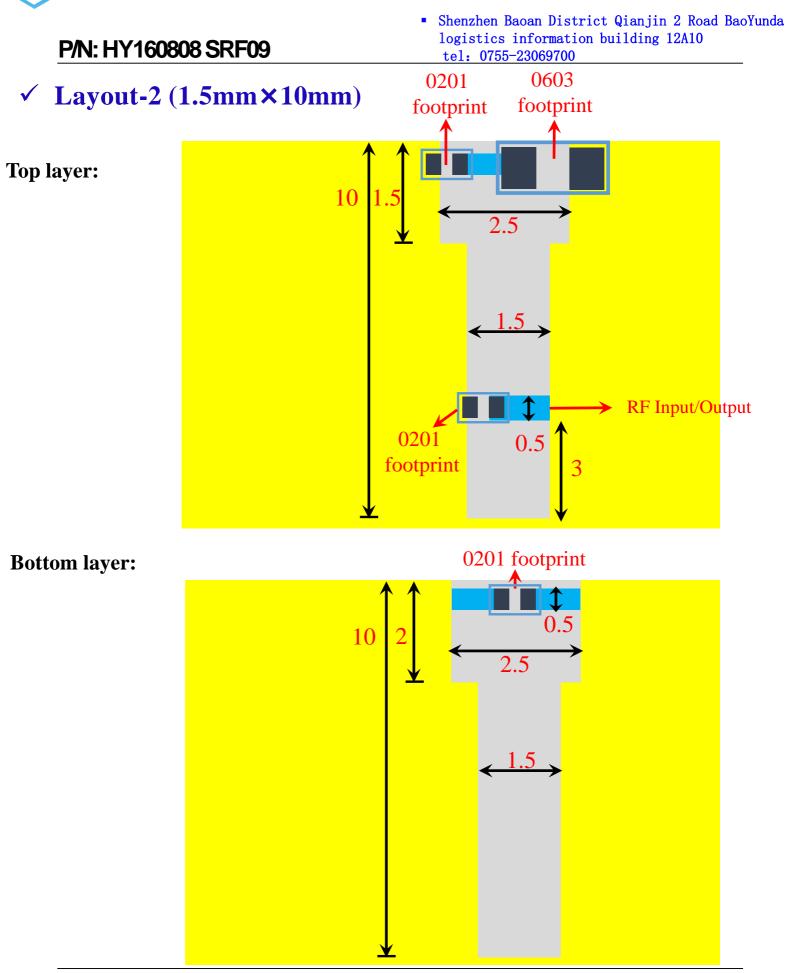


Symbols	L	W	Т	А	
Dimensions	$1.60 \pm 0.20$	$0.80 \pm 0.20$	$0.80 \pm 0.20$	$0.30 \pm 0.10$	

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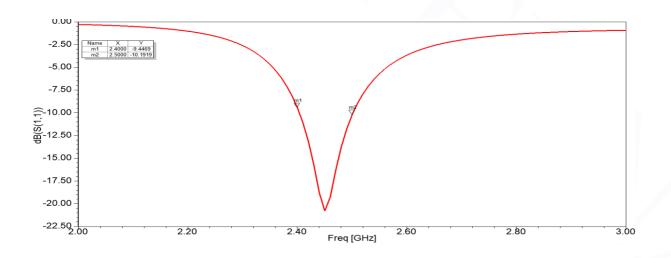


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### ✓ Electrical Characteristics:

	Feature	Specification		
1	Central frequency	2.45GHz		
2	Bandwidth	>150MHz		
3	Peak gain	2.78 dBi		
4	VSWR	<2		
5	Polarization	Linear		
6	Azimuth beamwidth	Omnidirectional		
7	Impedance	50 Ω		

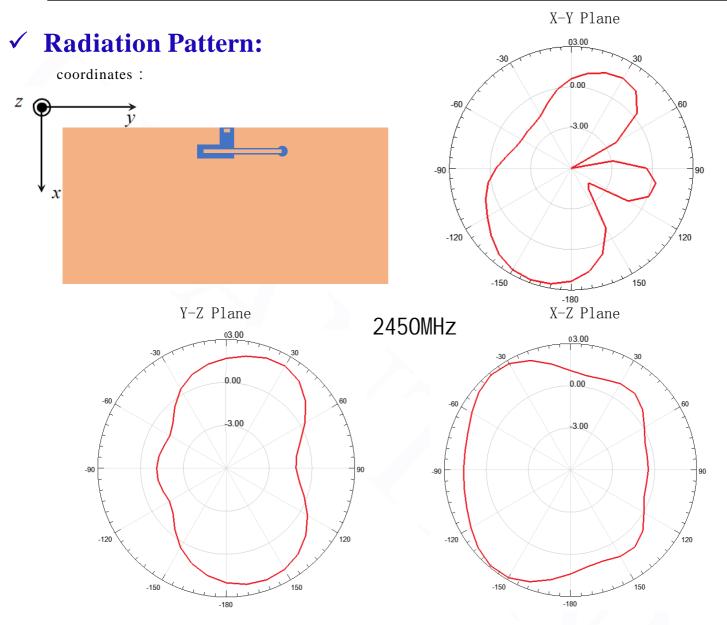
## Characteristic Curves:



深圳汉阳天线设计有限公司 Shenzhen Hanyang Antenna Design Co. Ltd.

- · 深圳市宝安区前进二路宝运达物流信息大厦12A10/12A11
- 青岛市崂山区松岭路399号海信产业园A1号楼606
  - 电话: 0755-23069700 传真: 0755-23069700

### P/N: HY160808 SRF07, HY160808 SRF08, HY160808 SRF09



## ✓ Radiation Performance:

Frequency	2400MHz	2450MHz	2500MHz
Avg. gain	-1.92	-1.35	-1.56
Peak gain	1.79	2.78	2.66
Efficiency	74.55	80.25	76.98

#### P/N: HY160808 SRF09

## ✓ Dependability Test

Test Temperature $25^{\circ}C \pm 5^{\circ}C$ Operating Temperature $-25^{\circ}C \sim +125^{\circ}C$ Temperature $5\sim 40^{\circ}C$ Relative Humidity $20\sim 70\%$ 

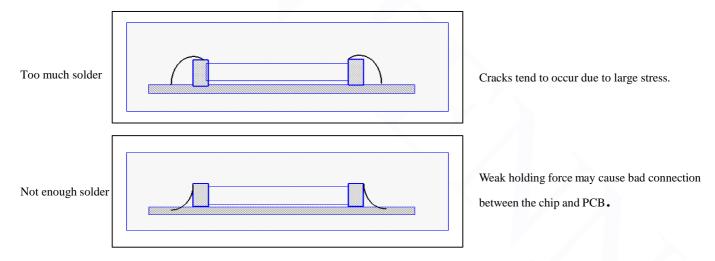
### ✓ Moisture Proof

Temperature: 40±2°C Humidity: 90~95%RH Duration: 500h Recovery conditions: Room temperature Recovery Time: 24h (Class1) or 48h (Class2)

### Solderability

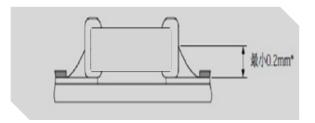
At least 95% of the terminal electrode is covered by new solder. Preheating conditions:80 to  $120^{\circ}$ C;  $10 \sim 30$ s. Solder Temperature: $235 \pm 5^{\circ}$ C Duration: $2 \pm 0.5$ s, Solder Temperature: $245 \pm 5^{\circ}$ C Duration: $2 \pm 0.5$ s

## Optimum Solder Amount for Reflow Soldering

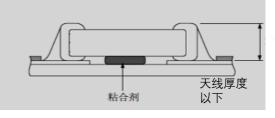


## ✓ Recommended Soldering Amounts

The optimal solder fillet amounts for re-flow soldering



The optimal solder fillet amounts for wave soldering



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#### P/N: HY160808 SRF09

## **Temperature Cycle Test**

 $10\pm1S$  Applied Force: 5N Duration:  $10\pm1S$ Preheating conditions: up-category temperature, 1h Recovery time:  $24\pm1h$ Initial Measurement Cycling Times: 5 times, 1 cycle, 4 steps:

Stage	Temperature(°C)	Time (minutes)
Step 1	Lower temperature limit (NPOX7R/X75/X65/X5R-55) Y5V:25 Z5U:10	30
Step 2	normal atmospheric temperature(+20)	2-3
Step 3	Upper line temperature $\binom{NPO'X7R/X7S:+125}{Y5V/Z5U/X5R:+85 X6S:+105}$	30
Step 4	normal atmospheric temperature(+20)	2-3

#### Resistance to Soldering Heat

Preheating 80 to  $120^{\circ}$ C;  $10 \sim 30$ s.SolderTemperature:  $235\pm5^{\circ}$ C; Duration: $2\pm0.5$ s; SolderTemperature:  $245\pm5^{\circ}$ C Duration:  $2\pm0.5$ s; Preheating 100 to  $200^{\circ}$ C;  $10\pm2$ min.

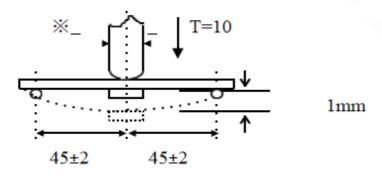
Solder Temperature: 265±5°C; Duration: 10±1s

Clean the capacitor with solvent and examine it with a 10X(min.) microscope.

Recovery Time: 24±2h

Recovery condition: Room temperature

#### ✓ Resistance to Flexure of Substrate



Test Board: Al<sub>2</sub>O<sub>3</sub> or PCB Warp: 1mm Speed: 0.5mm/sec. Unit: mm

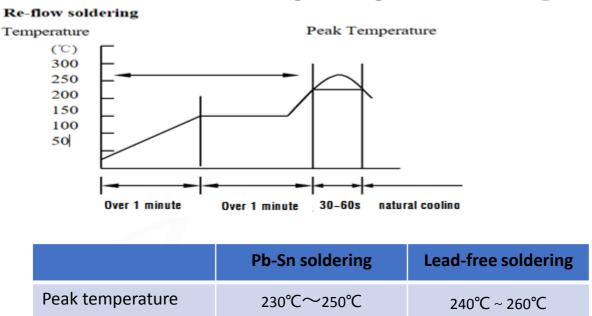
The measurement should be made with the board in the bending position.

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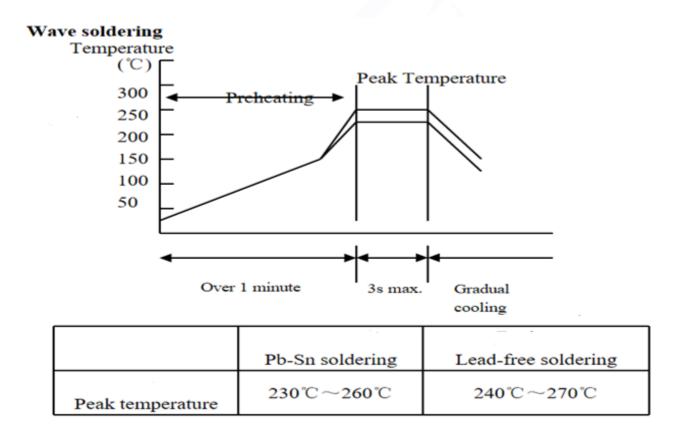
#### P/N: HY160808 SRF09

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The temperature profile for soldering

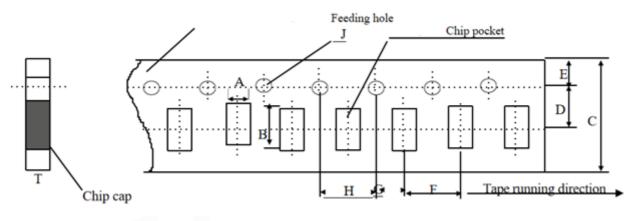
While in preheating, please keep the temperature difference between soldering temperature and surface temperature of chips as: T $\leq$ 150°C.



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#### P/N: HY160808 SRF09

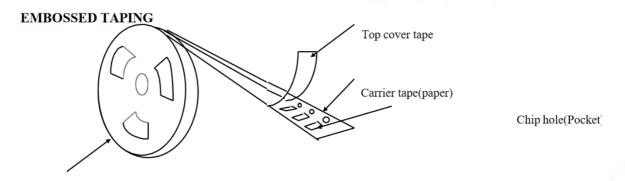
### ✓ Dimensions of paper taping



Unit: mm

Code	А	В	С	D*	E	F	G*	Н	J	Т
Cino	1.10	1.90	8.00	3.50	1.75	4.00	2.00	4.00	1.50	1.10
Size	±0.10	±0.10	±0.10	±0.05	±0.10	±0.10	±0.10	±0.10	-0/+0.10	Max

Reel (4000 pcs/Reel)



Polystyrene reel

## ✓ Storage Period

The guaranteed period for solderability is 6 months (Under deliver package condition). Temperature: $5\sim40^{\circ}$ C /Relative Humidity: $20\sim70\%$